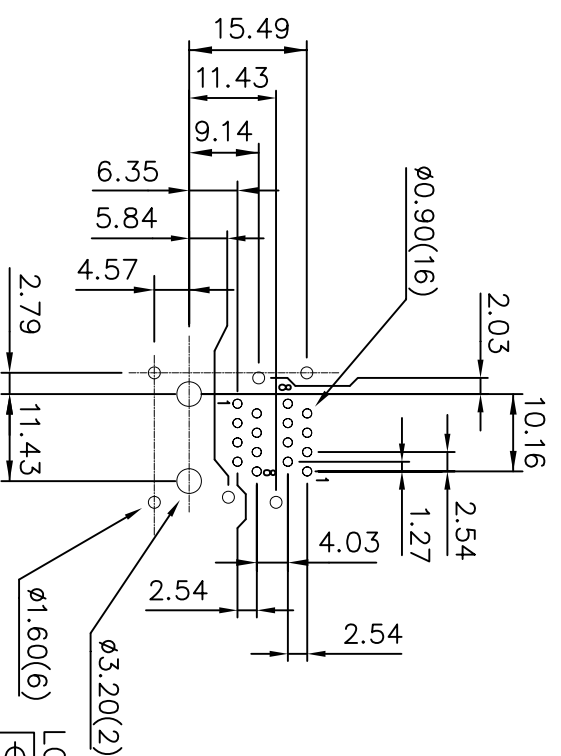
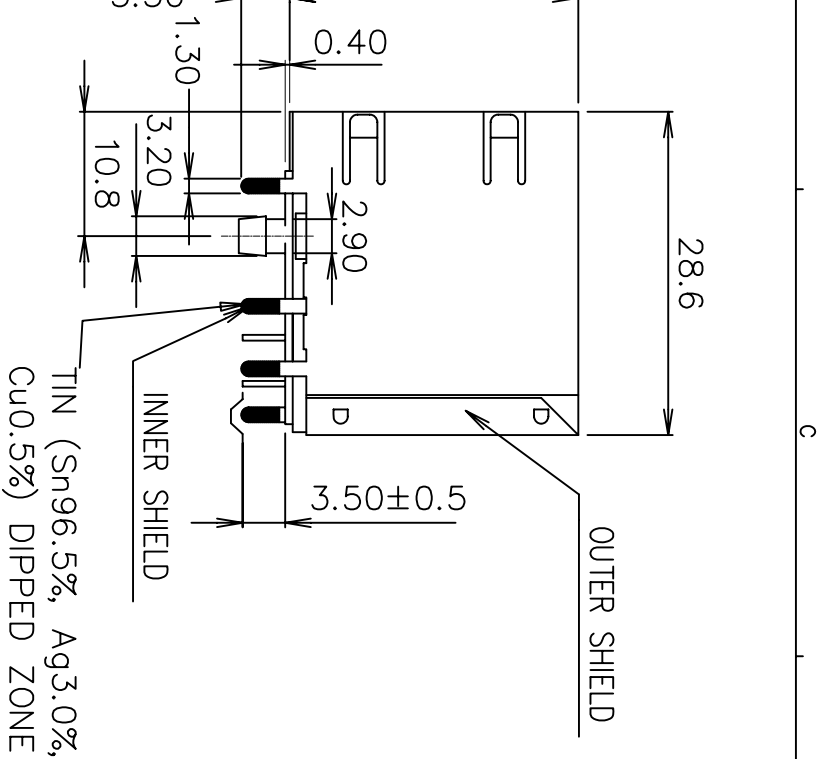




**THE DATASHEET OF
PK8071305122201S RMH2**

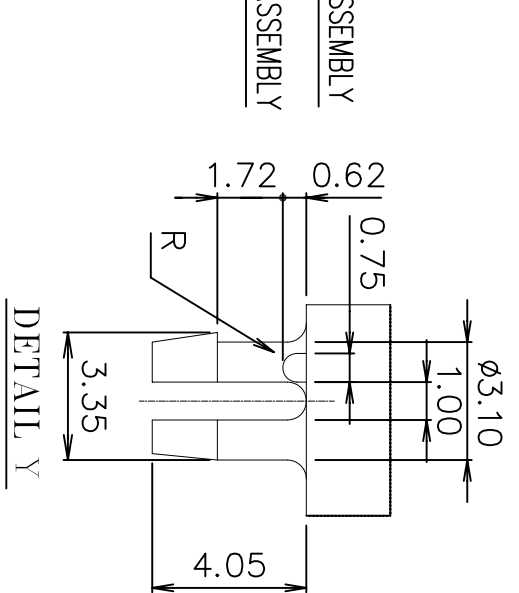


REVISIONS			
SYM ZONE	ECN, ERN NO.	DATE	APPRD.
A	PROPOSAL	AUG10/06	L.CHAN
B	ADD TIN DIPPED	SEP06/06	L.CHAN
C	CHANGE UNIT	SEP08/06	L.CHAN



RECOMMENDED P.C.B. LAYOUT
(COMPONENT SIDE OF BOARD)

LOCATE HOLES
 $\phi 0.13$
HOLES DIMENSIONS ARE BASIC



MATERIALS:
CONTACTS: PHOSPHOR BRONZE, SELECTIVELY PLATED
REFER TO P/N FOR GOLD THICKNESS ON MATING AREAS.
50 MICRO" MIN. NICKEL OVERALL.
GOLD FLASH ON CONTACT TAILS.

HOUSING: HIGH TEMPERATURE THERMOPLASTIC
COLOUR - BLACK, FLAMMABILITY RATING UL 94V-0
SHIELD: COPPER ALLOY WITH NICKEL PLATED AND TIN (Sn96.5%, Ag3.0%, Cu0.5%)
DIPPED PCB TAILS

RECOMMENDED SOLDERING TEMPERATURE:
WAVE SOLDERING OR REFLOW SOLDERING AT 260°C MAXIMUM
FOR 5 SEC MAXIMUM

HIGH TEMPERATURE MATERIAL

8 8 - 1 X 1 0 H
PLATING
5 μ " GOLD
15 μ " GOLD
30 μ " GOLD
50 μ " GOLD

DRAWN P/WANG	DATE	TITLE	
DESIGNED	AUG10/06	Stackable Modular Jack	
CHECKED CH/GOW	AUG10/06	2X1 PORT, SHIELD, 8 POS., 8 CONTACTS, - ROHS COMPLIANT	
I. E. APPRD.		DWG. NO.	DRAWING NO.
Q. A. APPRD.			P-RJE11-188-1X10-H
DWG. APPRD.		SCALE	WT. ----- SURF. ----- SHEET 1 OF 1
ENG. REL. NO.		DIMENSIONS ARE IN CODE ID. NO.	REV. C
REF.		mm	
		03554	

FOR PURPOSE AND SUCH INFORMATION
FOR MANUFACTURING
AMPHENOL CANADA CORP.

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